

12-08-1999

HEET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark OfficeTo the Honorable Assistant Secretary and
or copy(ies) thereof.

101216874

Please record the attached original document.

JC111 U. P. 29/11/99 12/03/99

1 Name of conveying party(ies):

Terumitsu KASHIMA

Additional name(s) of conveying party(ies) attached? NO

3 Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: November 15, 1999

2. Name and address of receiving party(ies):

Name: Culture Engineering Co., Ltd.

Street Address: 21st Floor Yebisu Garden Place Tower
20-3, Yebisu 4-chome, Shibuya-ku, Tokyo, Japan

Additional name(s) & address(es) attached? NO

4 Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: November 15, 1999

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? NO

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: WENDEROTH, LIND & PONACK, L.L.P.
Attn: Charles R. Watts, Esq.

Street Address: 2033 K Street, N.W., Suite 800

City: Washington, State: DC ZIP: 20006

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41). \$40.00

☒ Enclosed (Check No. 35446)
 Authorized to be charged to deposit account

8. Deposit account number: 23-0975

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Charles R. Watts, Reg. No. 33,142
Name of Person Signing

Signature

December 3, 1999
Date

Total number of pages including cover sheet: 3

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ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Terumitsu KASHIMA

Insert Name(s)
of Inventor(s)

the undersigned hereby sell(s) and assign(s) to

Culture Engineering Co., Ltd.

21st floor Yebisu Garden Place Tower 20-3, Yebisu 4-chome,
of Shibuya-ku, Tokyo, Japan

Insert Name(s)
of Assignee(s)

Address

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

DISPLAY RACK FOR GOODS

Title of
Invention

for which an application for patent in the United States has been executed by the undersigned on

Date of Signing
of Application

November 15, 1999

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, DC 20006, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date November 15, 1999, Name of Inventor Terumitsu Casimor

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Toshiko Tanaka

Witness Masanobu Takano

ACKNOWLEDGEMENT

_____ } ss

This _____ day of _____, 19____, before me
personally came the above-named _____

_____ to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL

Official Signature

Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date _____

Applicant Reference Number _____ Atty Docket No. _____

Title of Invention _____